

MOSFET

OptiMOS[™] 5 Power-MOSFET, 25 V

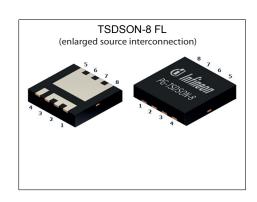
Features

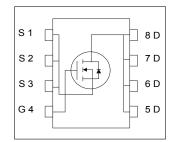
- Optimized for high performance buck converters Monolithic integrated Schottky-like diode Very low on-resistance $R_{\rm DS(on)}$ @ $V_{\rm GS}$ =4.5 V 100% avalanche tested

- N-channel
- Qualified according to JEDEC¹⁾ for target applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit	
V _{DS}	25	V	
R _{DS(on),max}	1.7	mΩ	
I _D	134	A	
Qoss	17.5	nC	
Q _G (0V4.5V)	10.5	nC	











Type / Ordering Code	Package	Marking	Related Links
BSZ017NE2LS5I	PG-TSDSON-8 FL	17NE25I	-



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Danamatan	Symbol	Values				
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - - -	- - - -	134 85 115 73 27	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	536	Α	<i>T</i> _C =25 °C
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	20	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse	E AS	-	-	40	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-16	-	16	V	-
Power dissipation	P _{tot}	-	-	50 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 K/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

2 Thermal characteristics

Table 3 Thermal characteristics

Downwotor	Cymbal	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	2.5	K/W	-
Device on PCB, 6 cm ² cooling area ²⁾	R _{thJA}	-	-	60	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter.	0	Values			1124		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	25	-	-	V	V _{GS} =0 V, I _D =10 mA	
Breakdown voltage temperature coefficient	$dV_{(BR)DSS}/dT_{j}$	-	15	-	mV/K	I _D =10 mA, referenced to 25 °C	
Gate threshold voltage	$V_{\mathrm{GS(th)}}$	1.2	-	2	V	V _{DS} =V _{GS} , I _D =250 μA	
Zero gate voltage drain current	l _{DSS}		- 0.5	0.5	mA	V _{DS} =20 V, V _{GS} =0 V, T _j =25 °C V _{DS} =20 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	1.9 1.45	2.3 1.7	mΩ	V _{GS} =4.5 V, I _D =20 A V _{GS} =10 V, I _D =20 A	
Gate resistance	R _G	-	0.85	1.4	Ω	-	
Transconductance	g fs	60	120	-	S		

Table 5 **Dynamic characteristics**

Damamatan	Or seeds all	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	1500	2000	pF	V _{GS} =0 V, V _{DS} =12 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	750	1000	pF	V _{GS} =0 V, V _{DS} =12 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	60	-	pF	V _{GS} =0 V, V _{DS} =12 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	4	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	4	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	20	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	3	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 Ω



Table 6 Gate charge characteristics¹⁾

Devementes	Symbol		Values			Nata / Tast Candition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	3.7	-	nC	V _{DD} =12 V, I _D =30 A, V _{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	2.4	-	nC	V _{DD} =12 V, I _D =30 A, V _{GS} =0 to 4.5 V
Gate to drain charge	Q _{gd}	-	2.3	-	nC	V _{DD} =12 V, I _D =30 A, V _{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	3.5	-	nC	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total	Qg	-	10.5	14	nC	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.4	-	V	V _{DD} =12 V, I _D =30 A, V _{GS} =0 to 4.5 V
Gate charge total ²⁾	Qg	-	22	30	nC	V _{DD} =12 V, I _D =30 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	9.8	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V
Output charge ²⁾	Qoss	-	17.5	24	nC	V _{DD} =12 V, V _{GS} =0 V

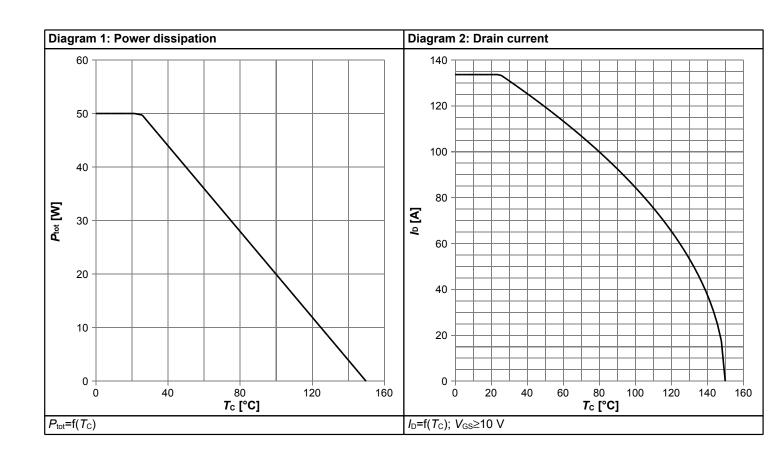
Table 7 Reverse diode

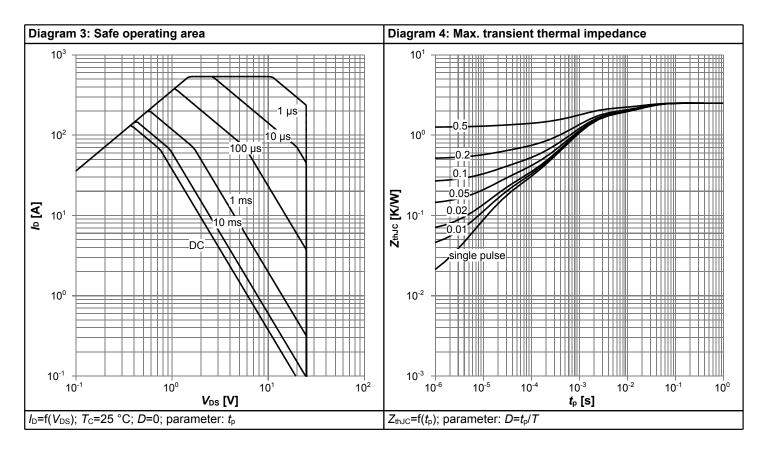
Dougnator	Cymahal		Values			Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	50	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	536	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.51	0.65	V	V _{GS} =0 V, I _F =7 A, T _j =25 °C
Reverse recovery charge	Qrr	-	12	-	nC	V_{R} =12 V, I_{F} = I_{S} , di_{F}/dt =400 A/ μ s

 $^{^{1)}}$ See "Gate charge waveforms" for parameter definition $^{2)}$ Defined by design. Not subject to production test.

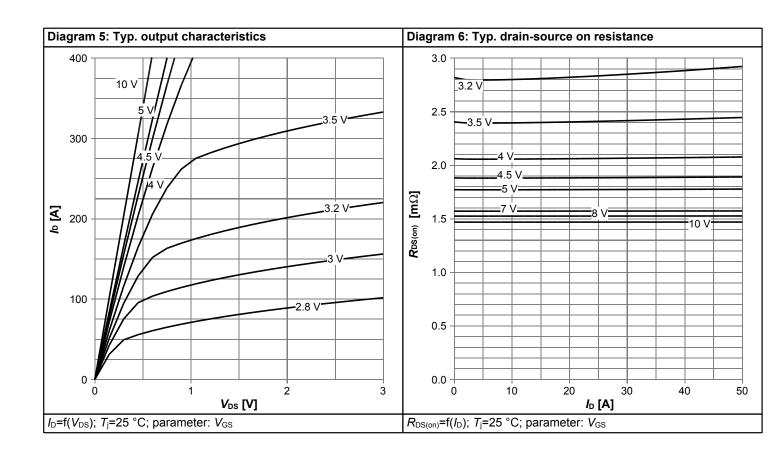


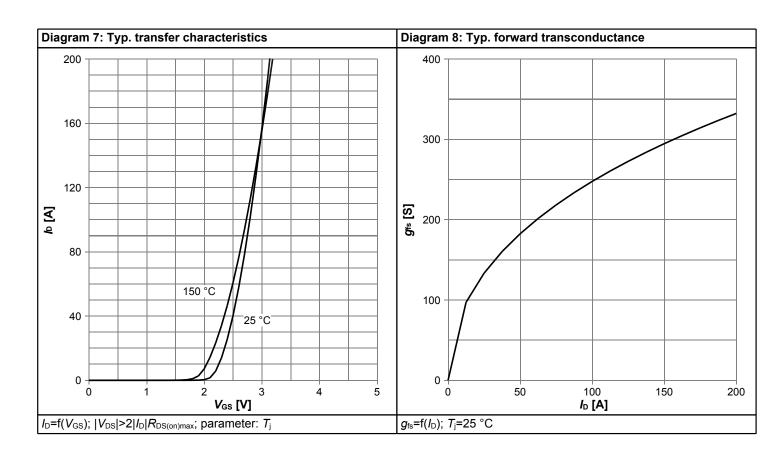
4 Electrical characteristics diagrams



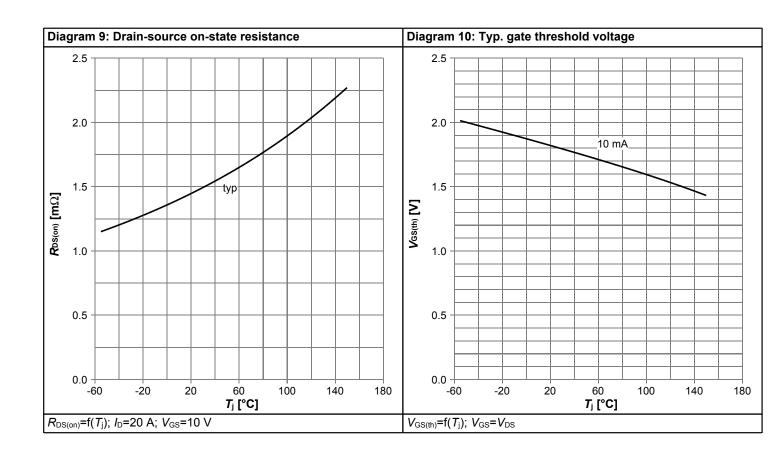


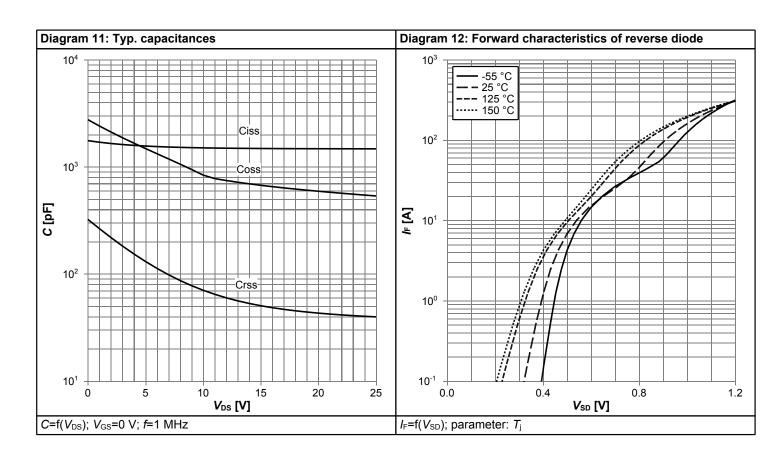




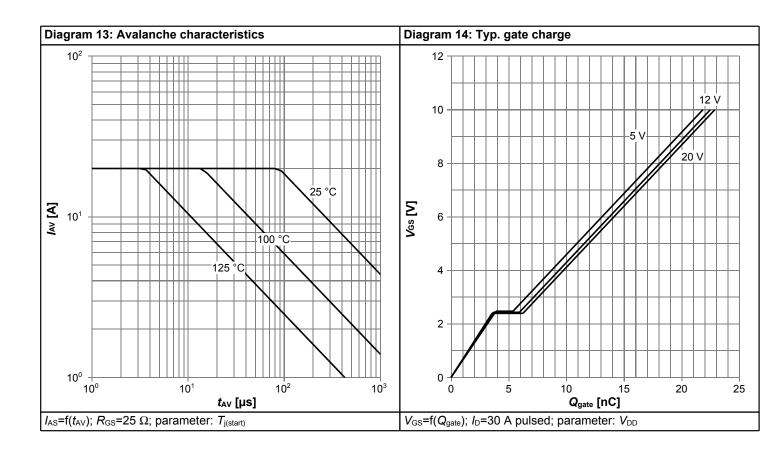


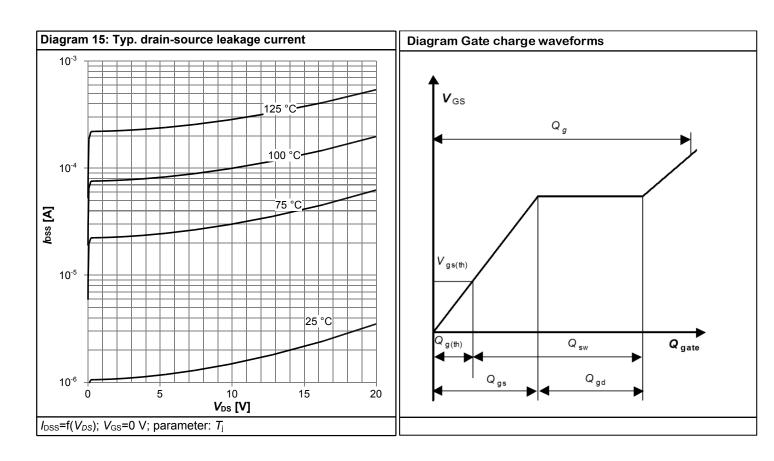














5 Package Outlines

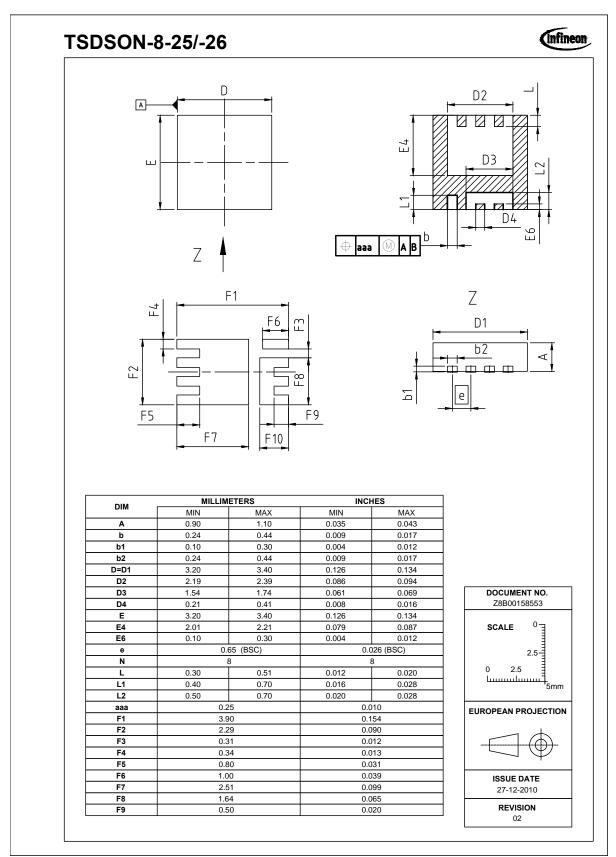


Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm/inches



Revision History

BSZ017NE2LS5I

Revision: 2020-06-17, Rev. 2.1

Previous Revision

1 10110401	Troviduo Novicion							
Revision	Date	Subjects (major changes since last revision)						
2.0	2015-08-17	Release of final version						
2.1	2020-06-17	Update current rating						

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